

N-Channel 60 V (D-S) Super Junction Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	R _{DS(on)} (mΩ)(Typ.) I _D (A) ^a (Ma				
60	1.3 at V _{GS} = 10 V	250			

FEATURES

- 175 °C Junction Temperature
- DT-Trench Power MOSFET

D

• Material categorization:





G C S N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (T _C =	25 °C, unless othe	rwise noted)		
Parameter	Symbol	Limit	Unit	
Gate-Source Voltage	V _{GS}	± 20	V	
Continuous Drain Current (T _J = 175 °C) ^b	T _C = 25 °C	I _D	250	
	T _C = 100 °C	'D	198 ^a	
Pulsed Drain Current	I _{DM}	1000	А	
Continuous Source Current (Diode Conduction)	۱ _S	250 ^a		
Avalanche Current	I _{AS}	220		
Single Avalanche Energy (Duty Cycle \leq 1 %)	L = 0.1 mH	E _{AS}	835	mJ
Maximum Power Dissipation	T _C = 25 °C	Pn -	362	W
	T _A = 25 °C	·D	8.5 ^{b, c}	vv
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 175	°C

THERMAL RESISTANCE RATINGS							
Parameter	Symbol	Typical	Maximum	Unit			
Maximum Junction-to-Ambient ^a	$t \le 10 \text{ sec}$	R _{thJA}	10	15	°C/W		
Maximum Junction-to-Ambient	Steady State		40	50			
Maximum Junction-to-Case		R _{thJC}	0.4	0.6			

Notes:

a. Package limited.

b. Surface mounted on 1" x 1" FR4 board.

c. t \leq 10 s.

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Parameter	Symbol	Test Conditions	Min.	Typ. ^a	Max.	Unit	
Static	<u> </u>						
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	60			V	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	1		3	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
Zero Gate Voltage Drain Current		$V_{DS} = 60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1	μA	
	I _{DSS}	V _{DS} = 48 V, V _{GS} = 0 V, T _J = 125 °C			50		
		V _{DS} = 48 V, V _{GS} = 0 V, T _J = 175 °C			250		
On-State Drain Current ^b	I _{D(on)}	V _{DS} = 5 V, V _{GS} = 10 V	250			А	
Drain-Source On-State Resistance ^b		V _{GS} = 10 V, I _D = 20 A		1.3	1.7	mΩ	
	P	V_{GS} = 10 V, I_{D} = 20 A, T_{J} = 125 °C		1.8	2.5		
	R _{DS(on)}	V _{GS} = 10 V, I _D = 10 A, T _J = 175 °C		2.9	4.3		
Forward Transconductance ^b	9 _{fs}	V _{DS} = 5 V, I _D = 20 A		108		S	
Dynamic							
Input Capacitance	C _{iss}			11880		pF	
Output Capacitance	C _{oss}	V_{GS} = 0 V, V_{DS} = 30 V, f = 1 MHz		1695			
Reverse Transfer Capacitance	C _{rss}			118			
Total Gate Charge ^c	Qg			125	193	nC	
Gate-Source Charge ^c	Q _{gs}	$V_{DS} = 30$ V, $V_{GS} = 10$ V, $I_{D} = 20$ A		32			
Gate-Drain Charge ^c	Q _{gd}			10		1	
Turn-On Delay Time ^c	t _{d(on)}			21		- ns	
Rise Time ^c	t _r	V_{DD} = 30 V, R_L = 0.6 Ω		26			
Turn-Off Delay Time ^c	t _{d(off)}	I_D = 20 A, V_{GEN} = 10 V, R_g = 2.5 Ω		119			
Fall Time ^c	t _f			33			
Source-Drain Diode Ratings and Cha	aracteristics (T _C = 25 °C)					
Pulsed Current	I _{SM}				1000	А	
Diode Forward Voltage	V _{SD}	I _F = 1 A, V _{GS} = 0 V		0.7	1.0	V	
Reverse Recovery Time	t _{rr}	I _F = 20 A, di/dt = 500 A/µs		35		ns	
Reverse Recovery Charge	Q _{rr}	I _F = 20 A, di/dt = 500 A/μs		116		nC	

Notes:

a. For design aid only; not subject to production testing.

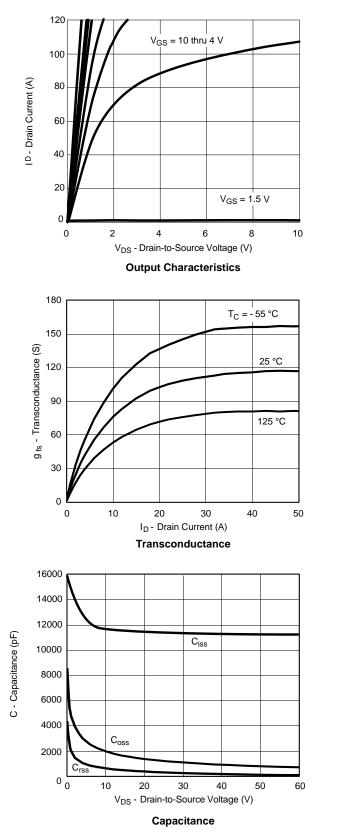
b. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

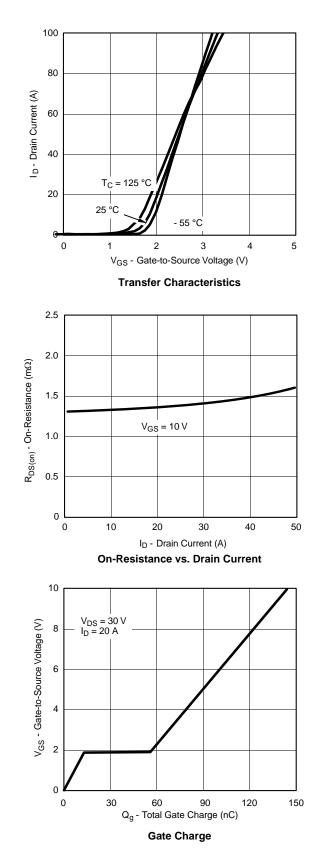
c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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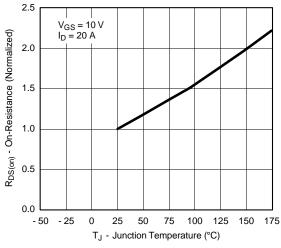
TYPICAL CHARACTERISTICS (25 °C unless noted)



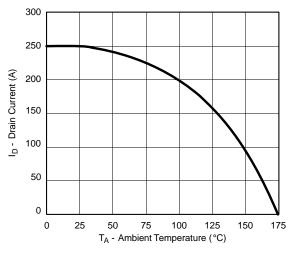


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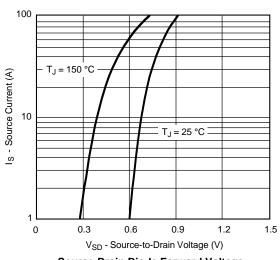
TYPICAL CHARACTERISTICS (25 °C unless noted)



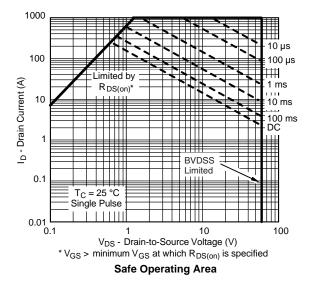
On-Resistance vs. Junction Temperature



Maximum Drain Current vs. Ambient Temperature

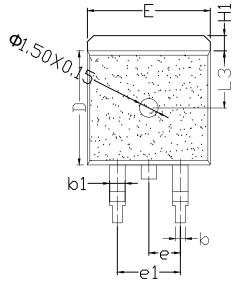


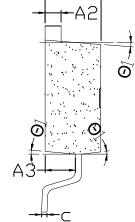
Source-Drain Diode Forward Voltage

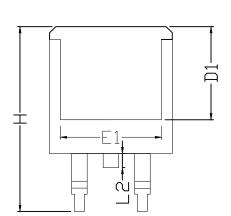


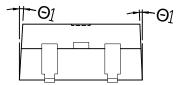


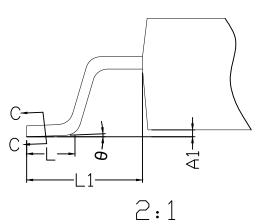
TO-263 PACKAGE INFORMATION











SYMBOL	mm			SYMBOL	mm			
STIVIDUL	MIN	NOM	MAX	STIVIDUL	MIN	NOM	MAX	
Α	4.40	4.50	4.60	е	2.50	2.54	2.58	
A1	0.00	0.10	0.20	e1	5.08REF			
A2	1.25	1.30	1.35	Н	15.00	15.15	15.30	
A3	2.40	2.50	2.60	H1	1.12	1.28	1.42	
b	0.75	0.80	0.85	L	2.10	2.23	2.36	
b1	1.25	1.33	1.42	L1	4.55	4.75	4.95	
С	0.45	0.50	0.55	L2	1.10	1.30	1.50	
D	9.10	9.20	9.30	L3	4.55	4.65	4.75	
D1	7.50REF			θ	0 °	2°	5°	
E	9.88	10.02	10.15	θ 1	2°	-	7°	
E1	9.78	9.88	10.10					

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